

3.2 x 2.7 x 1.1mm Red & Yellow green SMD

OSRG1206C1C

Ver.A.2

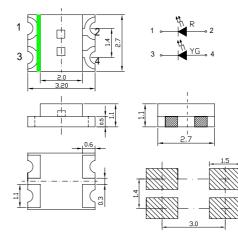
•Outline Dimension

Features

- Bi-Color
- Super high brightness of surface mount LED
- Water Clear Flat Mold
- Compact package outline (LxWxT) of 3.2mm x 2.7mm x 1.1mm
- Compatible to IR reflow soldering.

Applications

- Backlighting (switches, keys, etc.)
- Marker lights (e.g. steps, exit ways, etc.)



Unit

mA

mА

V

mW

-

Notes: 1. All dimensions are in millimeters ; 2. Tolerance is 0.10 mm unless otherwise noted.

Absolute Maximum Rating

Item

DC Forward Current

Reverse Voltage

Power Dissipation

Operating Temperature

Lead Soldering Temperature

Storage Temperature

Pulse Forward Current*

(Ta=25)

YG

30

100

5

78

Value

 $-40 \sim +85$

 $-40 \sim +85$

260

/5sec

(Ta=25)

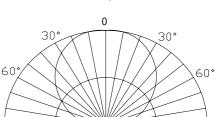
Red

30

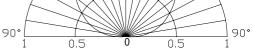
100

5

78



Directivity



*Pulse width Max 0.1ms, Duty ratio max 1/10

Electrical -Optical Characteristics

Symbol

 $I_{\rm F}$

 I_{FP}

 V_R

 P_{D}

Topr

Tstg

Tsol

	Color			$V_{\rm F}\left({ m V} ight)$		$I_R(\mu A)$	Iv(mcd)			λD(nm)			201/2(deg)
Part Number			Min.	Тур.	Max.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Тур.
				I _F =5mA		V _R =5V	I _F =5mA						
OSP C120(C1C	Red	HR	1.8	2.1	2.6	10	-	100	-	620	625	630	120
OSRG1206C1C	Yellow green	YG	1.8	2.2	2.6	10	-	40	-	565	570	575	120

Note: * Vf tolerance: ±0.05V

* Dominant wavelength tolerance: ±1nm

* Luminous intensity is NIST reading. Luminous intensity tolerance:±10%







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■ Recommended Soldering Temperature – Time Profile (Reflow Soldering)

Surface Mounting Condition

In automatic mounting of the SMD LEDs on printed circuit boards, any bending, expanding and pulling forces or shock against the SMD LEDs should be kept min. to prevent them from electrical failures and mechanical damages of the devices.

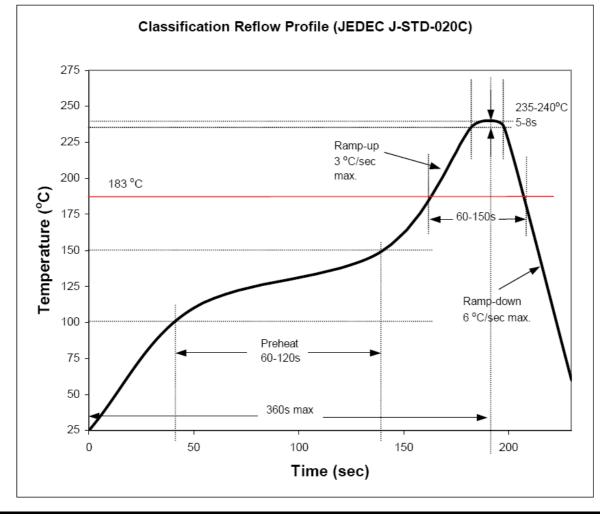
Soldering Reflow

-Soldering of the SMD LEDs should conform to the soldering condition in the individual specifications. -SMD LEDs are designed for Reflow Soldering.

-In the reflow soldering, too high temperature and too large temperature gradient such as rapid heating/cooling may cause electrical & optical failures and damages of the devices.

-We cannot guarantee the LEDs after they have been assembled using the solder dipping method.

1) Lead Solder



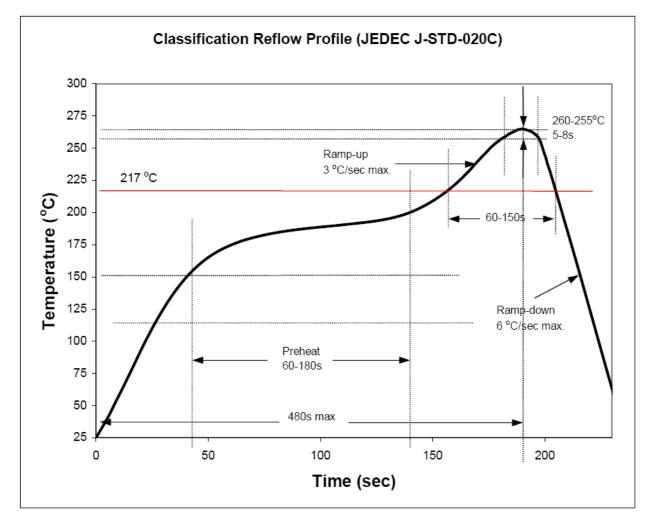




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2) Lead-Free Solder



3) Manual Soldering conditions.

- Lead Solder

Max. 300 for Max. 3sec, and only one time.

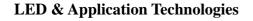
- Lead-free Solder

Max. 350 for Max. 3sec, and only one time.

- There is possibility that the brightness of LEDs is decreased, which is influenced by heat or ambient atmosphere during reflow. It is recommended to use the nitrogen reflow method.

- After LEDs have been soldered, repair should not be done. As repair is unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will be damaged by repairing or not.

- Reflow soldering should not be done more than two times.













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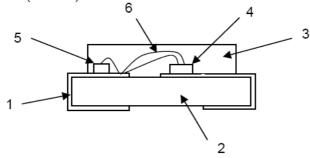
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Material

True green :

	Material
1. Lead-frame. / Soldering Leads	Cu Alloy With Ni, Au Plating.
2. PCB	BT Resin.
3. Encapsulant	Epoxy Resin.
4. Die	InGaN based
5. Zener diode	Si
6. Bonding wire	Au Chip : Ball Bonding / PCB : Ball Bonding

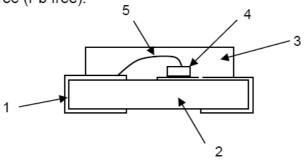
Note: Product is lead-free (Pb free).



White/ Blue/ Yellow green/ Yellow/ Orange/ Red :

	Material
1. Lead-frame. / Soldering Leads	Cu Alloy With Ni, Au Plating.
2. PCB	BT Resin.
3. Encapsulate	Epoxy Resin.
4. Die	AllnGaP based
5. Bonding wire	Au
	Chip : Ball Bonding / PCB : Ball Bonding

Note: Product is lead-free (Pb free).







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Reliability Test :

	Test Item	Test Conditions	Time	Test Q'ty	Fail Q'ty	O.K
1	Thermal Cycle Test (168 cycles)	H:+75°C 30 min ~ L:-35°C 30 min	168 Hrs	20	0	Pass
2	Thermal Shock Test (84 cycles, Rate= 5min)	H:+85°C (Holding 1 hr) ~ L:-40°C (Holding 1 hr)	168 Hrs	20	0	Pass
3	High Temp. Storage Test	Temp.:100°C	168 Hrs	20	0	Pass
4	Low Temp. Storage Test	Temp.:-40°C	168 Hrs	20	0	Pass
5	High Temp. High Humidity Test	85°C/85%RH,	168 Hrs	20	0	Pass
6	Press Cook Test	T=121°C, P=2atms H=100%RH	168 Hrs	20	0	Pass
7	Operating Life Test	IF=20 mA, 25°C	168 Hrs	20	0	Pass
8	IR-Reflow Test	Max 260°C (Pb free condition)	2 Times	10	0	Pass

Conclusions:

The reliability tests were designed to evaluate both package integrity as well as workability of product performance over time.

All samples have done well by completed test requirement and passed all the qualification criteria with zero failure. From design standpoint, the package is robust enough to meet its datasheet conditions. Based on the good result shows on the above test, this product is qualified and released for market.







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